PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
SHANGHAI HAITHINK INFOTECK CO., LTD	09/27/2024

RECEIVING PARTY DATA

Company Name:	Dayou Shuoneng Industry Co., Ltd	
Street Address:	21 TIANNINGSI DONGLI	
Internal Address:	XICHENG DISTRICT	
City:	BEIIING	
State/Country:	CHINA	
Postal Code:	100055	

PROPERTY NUMBERS Total: 1

Property Type	Number
Patent Number:	10695243

CORRESPONDENCE DATA

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NAME OF SUBMITTER:	Russ Weinzimmer
SIGNATURE:	Russ Weinzimmer
DATE SIGNED:	10/10/2024

Total Attachments: 1

source=ZHANG-001 ASSIGNMENT_Multipurpose_bed_patent_Change_Assignee[59]#page1.tiff

PATENT 508809051 REEL: 068870 FRAME: 0478

ASSIGNMENT

Whereas SHANGHAI HAITHINK INFOTECK CO., LTD, 290 ZHANGHENG ROAD, PUDONG, SHANGHAI, CHINA 201204 is the current owner of the following issued patent:

US Patent Number 10,695,243 B2, entitled "MULTI – FUNCTION MULTI – CONFIGURATION CARE BED FOR ENHANCED PATIENT COMFORT AND CAREGIVER CONVENIENCE" (hereinafter referred to as the "Invention").

And, whereas SHANGHAI HAITHINK INFOTECK CO., LTD intends to assign a 100% undivided interest in the Invention to: Dayou Shuoneng Industry Co., Ltd, 21 TIANNINGSI DONGLI, XICHENG DISTRICT, BEIJING, CHINA100055 (hereinafter referred to as "Assignee"),

and whereas Assignee is desirous of acquiring the entire right, title, and interest in the Invention:

I hereby assign and transfer a 100% undivided interest in the invention, and in the issued patent relating thereto, unto the Assignee;

And I further agree to execute all necessary and lawful future documents, including assignments in favor of Assignee, or its designees, as Assignee or its Assignees may from time-to-time present to me in order to perfect title in the Invention, modifications, improvements in the Invention, applications, and Letters Patent of the United States, and countries foreign thereto;

And I further agree to sign and properly execute such necessary and lawful papers for obtaining any reissue or reissues of any Letters Patent that may be granted for the Invention, as the Assignee thereof shall hereafter require and prepare at its own expense.

Signed by Si Cheng

on behalf of SHANGHAI HAITHINK INFOTECK CO., LTD

PATENT REEL: 068870 FRAME: 0479

RECORDED: 10/10/2024